

Vishay Siliconix

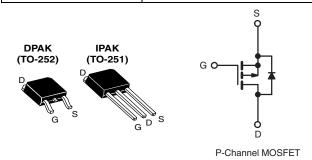
COMPLIANT

HALOGEN

FREE

Power MOSFET

PRODUCT SUMMARY					
V _{DS} (V)	- 60				
R _{DS(on)} (Ω)	V _{GS} = - 10 V 0.28				
Q _g (Max.) (nC)	19				
Q _{gs} (nC)	5.4				
Q _{gd} (nC)	11				
Configuration	Single				



FEATURES

- Dynamic dV/dt Rating
- Repetitive Avalanche Rated
- Surface Mount (IRFR9024, SiHFR9024)
- Straight Lead (IRFU9024, SiHFU9024)
- · Available in Tape and Reel
- P-Channel
- Fast Switching
- Material categorization: For definitions of compliance please see www.vishav.com/doc?99912

DESCRIPTION

Third generation power MOSFETs from Vishay provide the designer with the best combination of fast switching, ruggedized device design, low on-resistance and cost-effictiveness.

The DPAK is designed for surface mounting using vapor phase, infrared, or wave soldering techniques. The straight lead version (IRFU, SiHFU series) is for through-hole mounting applications. Power dissipation levels up to 1.5 W are possible in typical surface mount applications.

ORDERING INFORMATION						
Package	DPAK (TO-252)	DPAK (TO-252)	DPAK (TO-252)	DPAK (TO-252)	IPAK (TO-251)	
Lead (Pb)-free and Halogen-free	SiHFR9024-GE3	SiHFR9024TR-GE3ª	SiHFR9024TRL-GE3a	SiHFR9024TRR-GE3a	SiHFU9024-GE3	
Lead (Pb)-free	IRFR9024PbF	IRFR9024TRPbFa	IRFR9024TRLPbFa	IRFR9024TRRPbFa	IRFU9024PbF	
Lead (FD)-liee	SiHFR9024-E3	SiHFR9024T-E3a	SiHFR9024TL-E3a	SiHFR9024TR-E3a	SiHFU9024-E3	

Note

a. See device orientation.

ABSOLUTE MAXIMUM RATINGS $(T_C$	= 25 °C, unl	ess otherwis	se noted)		
PARAMETER			SYMBOL	LIMIT	UNIT
Drain-Source Voltage			V_{DS}	- 60	V
Gate-Source Voltage			V _{GS}	± 20	7 v
Continuous Proin Current	\/ at 10.\/	T _C = 25 °C	I _D	- 8.8	
Continuous Drain Current	Continuous Drain Current $V_{GS} \text{ at - 10 V} \frac{T_C = 25 ^{\circ}\text{C}}{T_C = 100 ^{\circ}\text{C}}$			- 5.6	Α
Pulsed Drain Current ^a			I _{DM}	- 35	
Linear Derating Factor			0.33 0.020	0.33	W/°C
Linear Derating Factor (PCB Mount) ^e				0.020	
Single Pulse Avalanche Energy ^b			E _{AS}	300	mJ
Repetitive Avalanche Current ^a			I _{AR}	- 8.8	Α
Repetitive Avalanche Energy ^a			E _{AR}	5.0	mJ
Maximum Power Dissipation	T _C =	25 °C	-	42	W
Maximum Power Dissipation (PCB Mount) ^e T _A = 25 °C			P _D	2.5]
Peak Diode Recovery dV/dt ^c			dV/dt	- 4.5	V/ns
Operating Junction and Storage Temperature Range			T _J , T _{stg}	- 55 to + 150	°C
Soldering Recommendations (Peak Temperature) ^d	for	10 s		260	

- a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11).
- b. V_{DD} = 25 V, starting T_J = 25 °C, L = 4.5 mH, R_g = 25 Ω , I_{AS} = 8.8 A (see fig. 12). c. I_{SD} \leq 11 A, dI/dt \leq 140 A/µs, V_{DD} \leq V_{DS}, T_J \leq 150 °C.
- d. 1.6 mm from case.
- e. When mounted on 1" square PCB (FR-4 or G-10 material).

S13-0168-Rev. D, 04-Feb-13 Document Number: 91278

IRFR9024, IRFU9024, SiHFR9024, SiHFU9024

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THERMAL RESISTANCE RATINGS						
PARAMETER	SYMBOL	MIN.	TYP.	MAX.	UNIT	
Maximum Junction-to-Ambient	R _{thJA}	-	-	110		
Maximum Junction-to-Ambient (PCB Mount) ^a	R _{thJA}	-	-	50	°C/W	
Maximum Junction-to-Case (Drain)	R _{thJC}	-	-	3.0]	

Note

a. When mounted on 1" square PCB (FR-4 or G-10 material).

PARAMETER	SYMBOL	TEST CONDITIONS		MIN.	TYP.	MAX.	UNIT
Static							
Drain-Source Breakdown Voltage	V _{DS}	$V_{GS} = 0 \text{ V}, I_D = 250 \mu\text{A}$		- 60	-	-	V
V _{DS} Temperature Coefficient	$\Delta V_{DS}/T_{J}$	Reference	e to 25 °C, I _D = 1 mA	-	- 0.063	-	V/°C
Gate-Source Threshold Voltage	V _{GS(th)}	V _{DS} =	· V _{GS} , I _D = 250 μA	- 2.0	-	- 4.0	V
Gate-Source Leakage	I _{GSS}	,	V _{GS} = ± 20 V	-	-	± 100	nA
Zon Oak William Burin Oamal		V _{DS} =	- 60 V, V _{GS} = 0 V	-	-	- 100	
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} = - 48 \	V, V _{GS} = 0 V, T _J = 125 °C	-	-	- 500	μA
Drain-Source On-State Resistance	R _{DS(on)}	V _{GS} = - 10 V	I _D = - 5.3 A ^b	-	-	0.28	Ω
Forward Transconductance	9 _{fs}	V _{DS} =	- 25 V, I _D = - 5.3 A	2.9	-	-	S
Dynamic							
Input Capacitance	C _{iss}		V _{GS} = 0 V,	-	570	-	
Output Capacitance	C _{oss}		$V_{DS} = -25 V$,	-	360	-	рF
Reverse Transfer Capacitance	C _{rss}	1	f = 1.0 MHz	-	65	-	
Total Gate Charge	Qg			-	-	19	
Gate-Source Charge	Q _{gs}	V _{GS} = - 10 V	$V_{GS} = -10 \text{ V}$ $I_D = -11 \text{ A}, V_{DS} = -48 \text{ V},$ see fig. 6 and 13 ^b		-	5.4	nC
Gate-Drain Charge	Q _{gd}	see lig. 0 and 13		-	-	11	
Turn-On Delay Time	t _{d(on)}			-	13	-	- ns
Rise Time	t _r	V _{DD} =	V _{DD} = - 30 V, I _D = - 11 A,		68	-	
Turn-Off Delay Time	t _{d(off)}	R_g = 18 Ω , R_D = 2.5 Ω , see fig. 10 ^b		-	15	-	
Fall Time	t _f			-	29	-	
Internal Drain Inductance	L _D	Between lead 6 mm (0.25")	']	-	4.5	-	
Internal Source Inductance	L _S	package and die contact	center of	-	7.5	-	nH
Drain-Source Body Diode Characteristic	s	-					
Continuous Source-Drain Diode Current	I _S	MOSFET s	the	-	-	- 8.8	. A
Pulsed Diode Forward Current ^a	I _{SM}	integral reverse p - n junction diode		-	-	- 35	^
Body Diode Voltage	V _{SD}	T _J = 25 °C,	$I_S = -8.8 \text{ A}, V_{GS} = 0 \text{ V}^b$	-	_	- 6.3	V
Body Diode Reverse Recovery Time	t _{rr}	T 25 °C 1	11	-	100	200	ns
Body Diode Reverse Recovery Charge	Q _{rr}	$-$ T _J = 25 °C, I _F = - 11 A, dI/dt = 100 A/ μ s ^b		-	0.32	0.64	μC
Forward Turn-On Time	t _{on}	Intrinsic tu	on is do	minated b	y L _S and	L _D)	

Notes

- a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11).
- b. Pulse width \leq 300 μ s; duty cycle \leq 2 %.

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TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

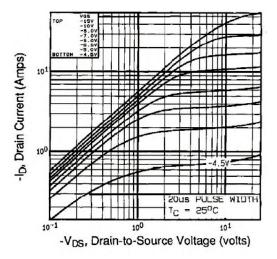


Fig. 1 - Typical Output Characteristics, T_C = 25 °C

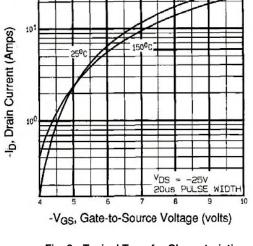


Fig. 3 - Typical Transfer Characteristics

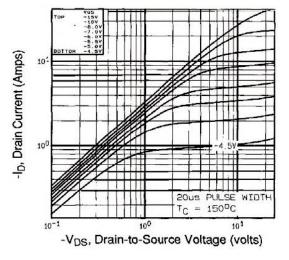


Fig. 2 -Typical Output Characteristics, T_C = 150 °C

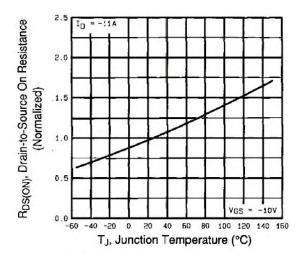


Fig. 4 - Normalized On-Resistance vs. Temperature

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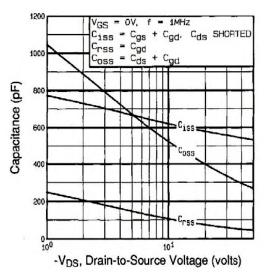


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

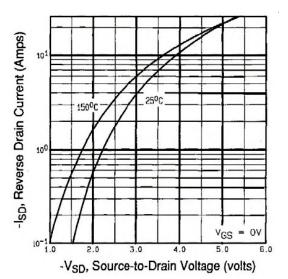


Fig. 7 - Typical Source-Drain Diode Forward Voltage

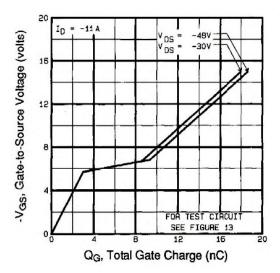


Fig. 6 - Typical Gate Charge vs. Gate-to-Source Voltage

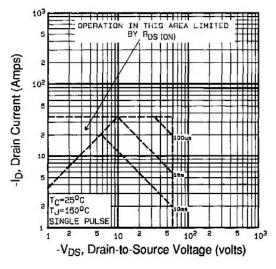


Fig. 8 - Maximum Safe Operating Area

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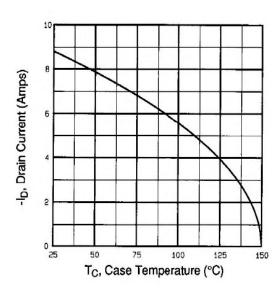


Fig. 9 - Maximum Drain Current vs. Case Temperature

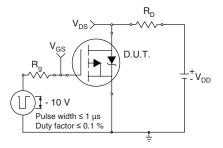


Fig. 10a - Switching Time Test Circuit

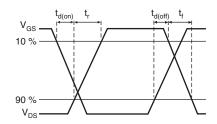


Fig. 10b - Switching Time Waveforms

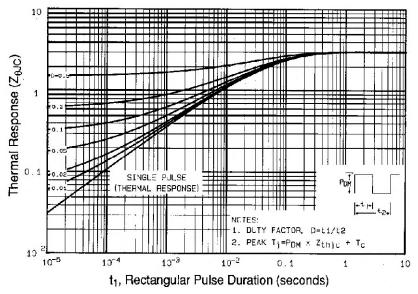


Fig. 11 - Maximum Effective Transient Thermal Impedance, Junction-to-Case

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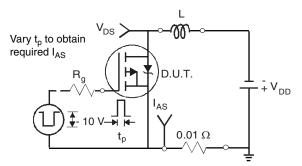


Fig. 12a - Unclamped Inductive Test Circuit

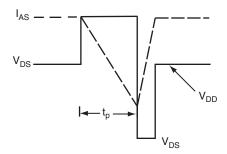


Fig. 12b - Unclamped Inductive Waveforms

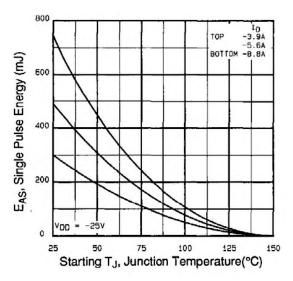


Fig. 12c - Maximum Avalanche Energy vs. Drain Current

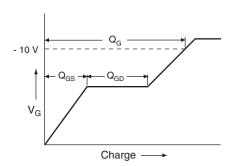


Fig. 13a - Basic Gate Charge Waveform

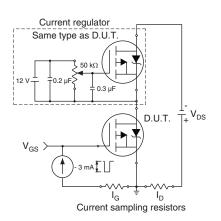
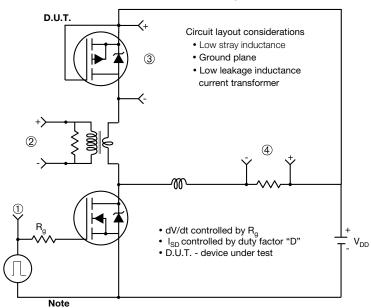


Fig. 13b - Gate Charge Test Circuit

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Peak Diode Recovery dV/dt Test Circuit



• Compliment N-Channel of D.U.T. for driver

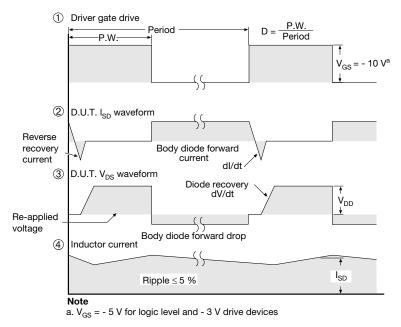


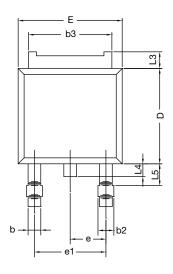
Fig. 14 - For P-Channel

Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package/tape drawings, part marking, and reliability data, see www.vishay.com/ppg?91278.

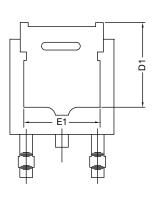


TO-252AA Case Outline

VERSION 1: FACILITY CODE = Y







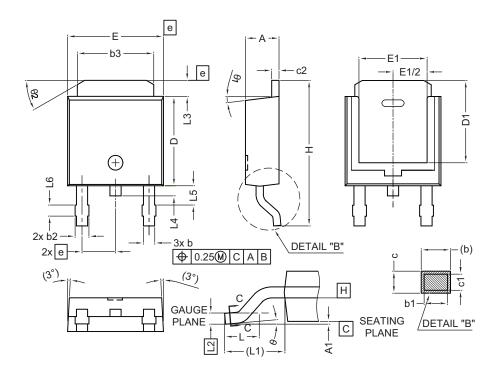
	MILLIMETERS		
DIM.	MIN.	MAX.	
A	2.18	2.38	
A1	-	0.127	
b	0.64	0.88	
b2	0.76	1.14	
b3	4.95	5.46	
С	0.46	0.61	
C2	0.46	0.89	
D	5.97	6.22	
D1	4.10	-	
Е	6.35	6.73	
E1	4.32	-	
Н	9.40	10.41	
е	2.28	BSC	
e1	4.56 BSC		
L	1.40	1.78	
L3	0.89	1.27	
L4	-	1.02	
L5	1.01	1.52	

Note

• Dimension L3 is for reference only



VERSION 2: FACILITY CODE = N



	MILLIMETERS			
DIM.	MIN.	MAX.		
Α	2.18	2.39		
A1	-	0.13		
b	0.65	0.89		
b1	0.64	0.79		
b2	0.76	1.13		
b3	4.95	5.46		
С	0.46	0.61		
c1	0.41	0.56		
c2	0.46	0.60		
D	5.97	6.22		
D1	5.21	=		
E	6.35	6.73		
E1	4.32	-		
е	2.29 BSC			
Н	9.94	10.34		

	MILLIMETERS			
DIM.	MIN.	MAX.		
L	1.50	1.78		
L1	2.74	ł ref.		
L2	0.51	BSC		
L3	0.89	1.27		
L4	-	1.02		
L5	1.14	1.49		
L6	0.65	0.85		
θ	0°	10°		
θ1	0°	15°		
θ2	25°	35°		

Notes

- Dimensioning and tolerance confirm to ASME Y14.5M-1994
- All dimensions are in millimeters. Angles are in degrees
- Heat sink side flash is max. 0.8 mm
- Radius on terminal is optional

ECN: E19-0649-Rev. Q, 16-Dec-2019

DWG: 5347



TO-251AA (HIGH VOLTAGE)



Section B - B and C - C

	MILLIMETERS		INC	HES
DIM.	MIN.	MAX.	MIN.	MAX.
Α	2.18	2.39	0.086	0.094
A1	0.89	1.14	0.035	0.045
b	0.64	0.89	0.025	0.035
b1	0.65	0.79	0.026	0.031
b2	0.76	1.14	0.030	0.045
b3	0.76	1.04	0.030	0.041
b4	4.95	5.46	0.195	0.215
С	0.46	0.61	0.018	0.024
c1	0.41	0.56	0.016	0.022
c2	0.46	0.86	0.018	0.034
D	5.97	6.22	0.235	0.245

	MILLIMETERS		INC	HES
DIM.	MIN.	MAX.	MIN.	MAX.
D1	5.21	-	0.205	-
Е	6.35	6.73	0.250	0.265
E1	4.32	-	0.170	-
е	2.29 BSC		2.29 BSC	
L	8.89	9.65	0.350	0.380
L1	1.91	2.29	0.075	0.090
L2	0.89	1.27	0.035	0.050
L3	1.14	1.52	0.045	0.060
θ1	0'	15'	0'	15'
θ2	25'	35'	25'	35'

ECN: S-82111-Rev. A, 15-Sep-08

DWG: 5968

Notes

- 1. Dimensioning and tolerancing per ASME Y14.5M-1994.
- 2. Dimension are shown in inches and millimeters.
- 3. Dimension D and E do not include mold flash. Mold flash shall not exceed 0.13 mm (0.005") per side. These dimensions are measured at the outermost extremes of the plastic body.
- 4. Thermal pad contour optional with dimensions b4, L2, E1 and D1.
- 5. Lead dimension uncontrolled in L3.
- 6. Dimension b1, b3 and c1 apply to base metal only.
- 7. Outline conforms to JEDEC outline TO-251AA.

Document Number: 91362 Revision: 15-Sep-08



RECOMMENDED MINIMUM PADS FOR DPAK (TO-252)



Recommended Minimum Pads Dimensions in Inches/(mm)

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APPLICATION NOTE



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